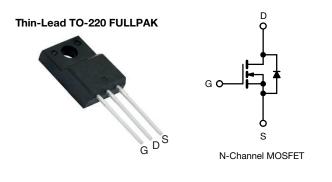
SiHA12N60E



www.vishay.com

E Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} max. (Ω) at 25 °C	V _{GS} = 10 V 0.38				
Q _g max. (nC)	58				
Q _{gs} (nC)	6				
Q _{gd} (nC)	13				
Configuration	Single				

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (C_{iss})
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Consumer
 - Adaptors
 - Televisions
 - Game console
- Computing
 - Adaptors
 - ATX power supply

ORDERING INFORMATION				
Package	Thin-Lead TO-220 FULLPAK			
Lead (Pb)-free	SiHA12N60E-E3			
Lead (Pb)-free and halogen-free	SiHA12N60E-GE3			

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	600	- V	
Gate-source voltage			V _{GS}	± 30		
Continuous drain surrant $(T_{1} - 150 ^{\circ}\text{C})^{\frac{1}{2}}$	$V_{GS} \text{ at } 10 \text{ V} \qquad \frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$			12		
Continuous drain current (T _J = 150 °C) ^e	V _{GS} at 10 V	T _C = 100 °C	ID	7.8	A	
Pulsed drain current ^a			I _{DM}	27	1	
Linear derating factor				0.26	W/°C	
Single pulse avalanche energy ^b			E _{AS}	117	mJ	
Maximum power dissipation			PD	33	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	$T_J = 1$	125 °C	-1\ / / -1+	70		
Reverse diode dV/dt ^d			dV/dt	5	V/ns	
Soldering recommendations (peak temperature) ^c	for 10 s			300	°C	
Mounting torque	M3 screw			0.6	Nm	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 11.6 mH, R_g = 25 $\Omega,\,I_{AS}$ = 4.5 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D, \, dl/dt$ = 100 A/µs, starting T_J = 25 °C

e. Limited by maximum junction temperature



RoHS COMPLIANT HALOGEN FREE



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DADAMETER	INGS	TVD	Г	MAY			LINUT	
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	- 65			°C/W			
Maximum junction-to-case (drain)	R _{thJC}	- 3.8						
SPECIFICATIONS (T _J = 25 $^{\circ}$ C,	unless otherwi	se noted)						
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNI	
Static	1					1	•	
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 µA		600	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	Reference to 25 °C, $I_D = 1 \text{ mA}$		-	0.71	-	V/°
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 µA	2	-	4	V
		$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	n/	
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 30$	V	-	-	± 1	μA
Zeve este velte es elve a summert		V _{DS} =	= 600 V, V _G	_S = 0 V	-	-	1	
Zero gate voltage drain current	IDSS	V _{DS} = 480 \	/, V _{GS} = 0 V	, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V		_D = 6 A	-	0.32	0.38	Ω
Forward transconductance	g _{fs}	V _{DS} = 40 V, I _D = 8 A		-	3.8	-	S	
Dynamic	•	•			•	•	•	
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	937	-	-	
Output capacitance	C _{oss}			-	53	-		
Reverse transfer capacitance	C _{rss}			-	5	-		
Effective output capacitance, energy related ^a	C _{o(er)}	$V_{DS} = 0$ V to 480 V, $V_{GS} = 0$ V		-	41	-	pl	
Effective output capacitance, time related ^b	C _{o(tr)}			-	136	-		
Total gate charge	Qg	V _{GS} = 10 V I _D = 6 A, V _{DS} = 480 V		-	29	58	nC	
Gate-source charge	Q _{gs}			-	6	-		
Gate-drain charge	Q _{gd}				-	13	-	1
Turn-on delay time	t _{d(on)}				-	14	28	
Rise time	t _r	V_{DD} = 480 V, I_D = 6 A, V_{GS} = 10 V, R_g = 9.1 Ω		-	19	38	- ns	
Turn-off delay time	t _{d(off)}			-	35	70		
Fall time	t _f			-	19	38		
Gate input resistance	Rg	f = 1 MHz, open drain		-	1.1	-	Ω	
Drain-Source Body Diode Characterist	ics							
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	12		
Pulsed diode forward current	I _{SM}			-	-	48	A	
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 6 A, V _{GS} = 0 V		-	-	1.2	V	
Reverse recovery time	t _{rr}	T _J = 25 °C, $I_F = I_S = 6 A$, dl/dt = 100 A/µs, $V_B = 25 V$		-	350	-	n	
Reverse recovery charge	Q _{rr}			-	4	-	μ(
Reverse recovery current	I _{RRM}		100 Av µo, V	$ai/at = 100 A/\mu s, v_R = 25 V$		19	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

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SiHA12N60E

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

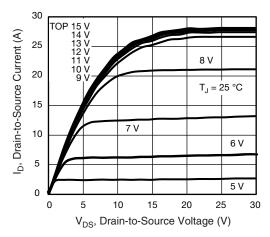


Fig. 1 - Typical Output Characteristics

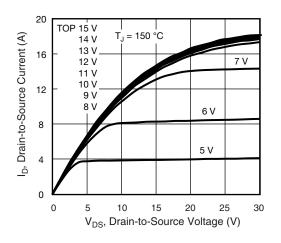
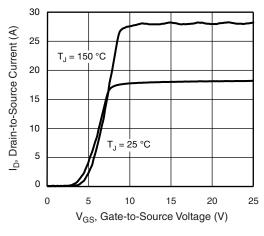


Fig. 2 - Typical Output Characteristics





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3 6 On Resistance (Normalized) 2.5 R_{DS(on)}, Drain-to-Source 2 1.5 1 10 0.5 0 - 60 - 40 - 20 0 20 40 60 80 100 120 140 160 T_J, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

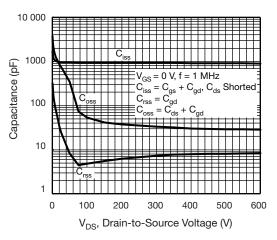


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

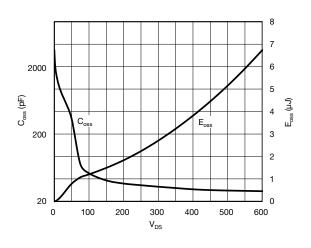


Fig. 6 - $C_{\rm oss}$ and $E_{\rm oss}$ vs. $V_{\rm DS}$

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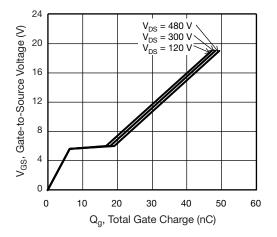


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

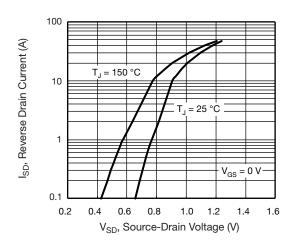


Fig. 8 - Typical Source-Drain Diode Forward Voltage

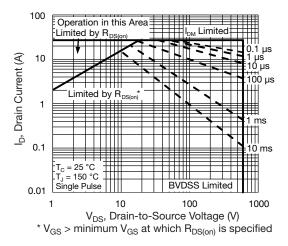


Fig. 9 - Maximum Safe Operating Area

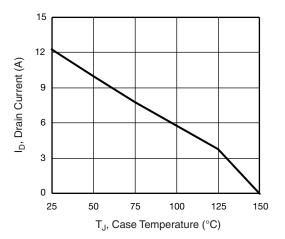


Fig. 10 - Maximum Drain Current vs. Case Temperature

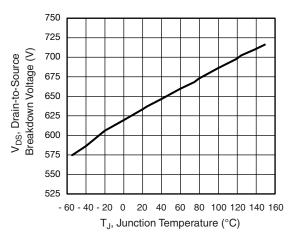


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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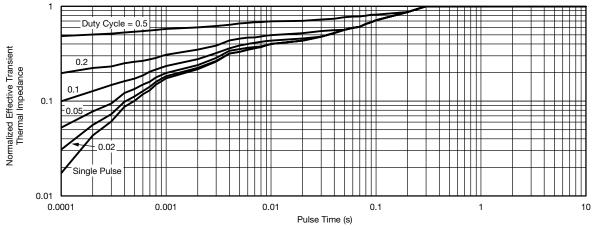
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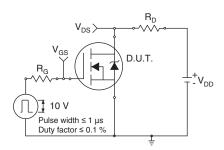


Fig. 13 - Switching Time Test Circuit

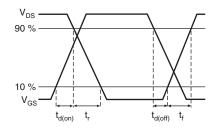


Fig. 14 - Switching Time Waveforms

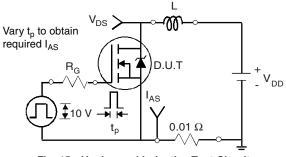


Fig. 15 - Unclamped Inductive Test Circuit

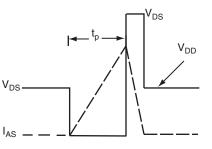


Fig. 16 - Unclamped Inductive Waveforms

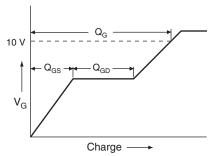


Fig. 17 - Basic Gate Charge Waveform

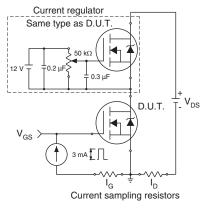


Fig. 18 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit

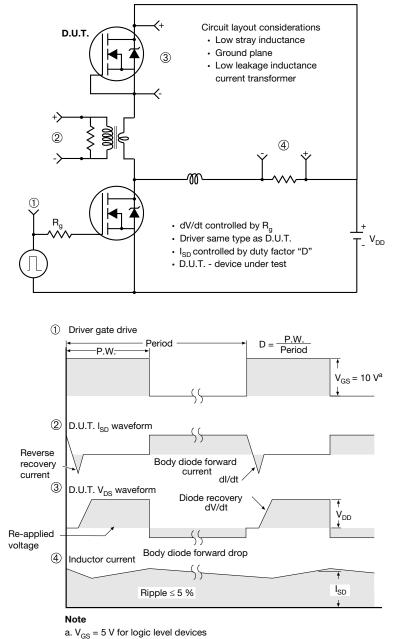


Fig. 19 - For N-Channel

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TO-220 FULLPAK Thin Lead





		DIMEN	ISIONS	
SYMBOL	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	•	·	

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